

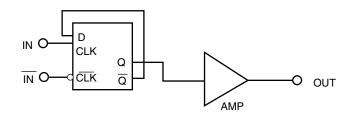
3.0 GHz DIVIDE BY 2 PRESCALER

UPB1508GV

FEATURES

- HIGH FREQUENCY OPERATION TO 3 GHz
- FIXED DIVIDE RATIO: ÷2
- LOW CURRENT CONSUMPTION: 12 mA at 5 V
- SMALL PACKAGE: 8 pin SSOP
- AVAILABLE IN TAPE AND REEL

INTERNAL BLOCK DIAGRAM



DESCRIPTION

NEC's UPB1508GV is a Silicon RFIC digital prescaler manufactured with the NESAT[™] IV silicon bipolar process. It features frequency response to 3 GHz, a divide-by-two ratio, and operates on a 5 volt supply while drawing only 12 mA. The device is housed in a small 8 pin SSOP package that contributes to system miniaturization. The low power consumption and wide frequency operation makes the device well suited for use in a PLL synthesizer for UHF/VHF TV and DBS tuner applications.

ELECTRICAL CHARACTERISTICS (TA = -40 to +85°C, Vcc = 4.5 to 5.5 V, Zs = ZL = 50 Ω)

PART NUMBER PACKAGE OUTLINE			UPB1508GV S08		
SYMBOLS	PARAMETERS AND CONDITIONS	UNITS	MIN	ТҮР	МАХ
lcc	Supply Current	mA	7.6	12	14.5
fin (U)	Upper Limit Operating Frequency, $P_{IN} = -10$ to +6 dBm $P_{IN} = -15$ to +6 dBm	GHz GHz	3.0 2.7		
fin (L)	Lower Limit Operating Frequency, PIN = -15 to +6 dBm	GHz			0.5
Pin	Input Power, fin = 2.7 to 3.0 GHz fin = 0.5 to 2.7 GHz	dBm dBm	-10 -15		+6 +6
Pout	Output Power, PIN =0 dBm, fIN = 2 GHz	dBm	-12	-7	

ABSOLUTE MAXIMUM RATINGS¹ (TA = 25°C)

SYMBOLS	PARAMETERS	UNITS	RATINGS
Vcc	Supply Voltage	V	6.0
VIN	Input Voltage	V	6.0
Рт	Total Power Dissipation ²	mW	250
Тор	Operating Temperature	°C	-40 to +85
Tstg	Storage Temperature	°C	-55 to +150

Notes:

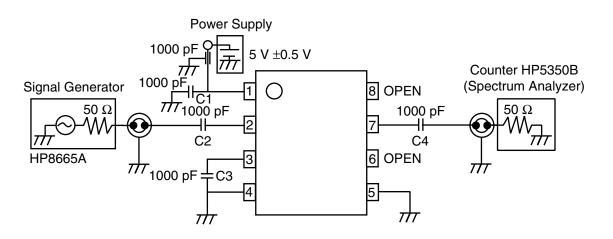
1. Operation in excess of any one of these parameters may result in permanent damage.

 Mounted on a double-sided copper clad 50x50x1.6 mm epoxy glass PWB (TA = +85°C).

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	UNITS	MIN	ТҮР	МАХ
Vcc	Supply Voltage	V	4.5	5.0	5.5
Тор	Operating Temperature	°C	-40	+25	+85

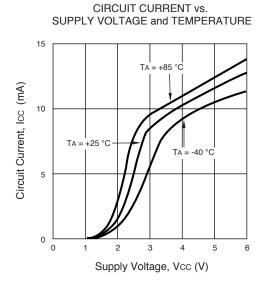
TEST CIRCUIT



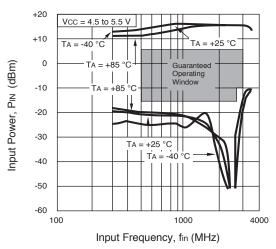
PIN DESCRIPTIONS

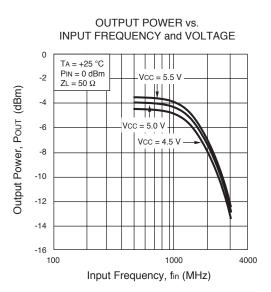
Pin no.	Symbol	Applied Voltage	Pin Voltage	Description
1	Vcc	4.5 to 5.5		Power supply pin. This pin must be equipped with bypass capacitor (eg 1000 pF) to ground.
2	IN		1.7 to 4.95	Signal input pin. This pin should be coupled with a capacitor (eg 1000 pF).
3	ĪN		1.7 to 4.95	Signal input bypass pin. This pin must be equipped with a bypass capacitor (eg 1000 pF) to ground.
4, 5	GND	0		Ground pin. Ground pattern on the board should be formed as wide as possible to minimize ground impedance.
6	NC			No connection. This pin should be left open.
7	OUT		1.0 to 4.7	Divided frequency output pin. This pin should be coupled to load device with a capacitor (eg 1000 pF).
8	NC			No connection. This pin should be left open.

TYPICAL PERFORMANCE CURVES (Unless otherwise specified, TA = 25°C)

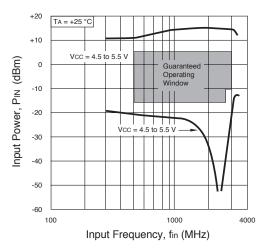


INPUT POWER vs. INPUT FREQUENCY and TEMPERATURE

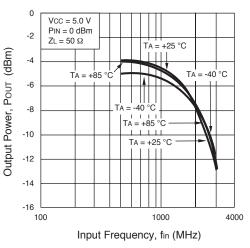




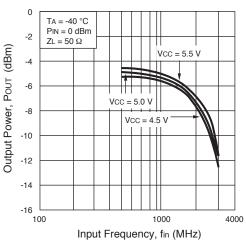
INPUT POWER vs. INPUT FREQUENCY and VOLTAGE



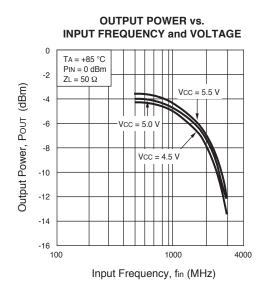
OUTPUT POWER vs. INPUT FREQUENCY and VOLTAGE



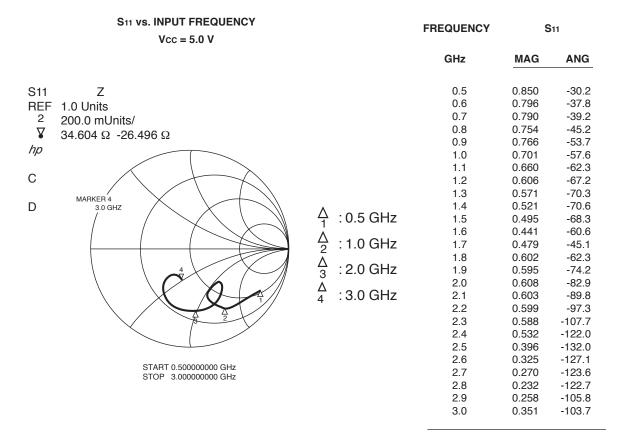
OUTPUT POWER vs. INPUT FREQUENCY and VOLTAGE



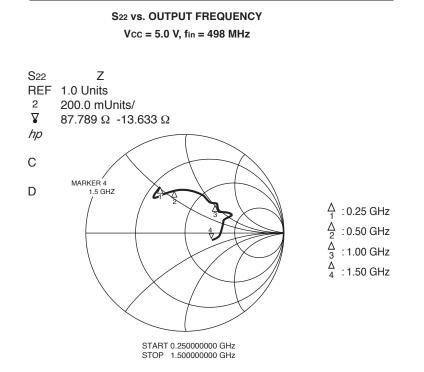
TYPICAL PERFORMANCE CURVES (Unless otherwise specified, TA = 25 °C)



TYPICAL SCATTERING PARAMETERS (TA = 25 °C)



TYPICAL SCATTERING PARAMETERS (TA = 25 °C)

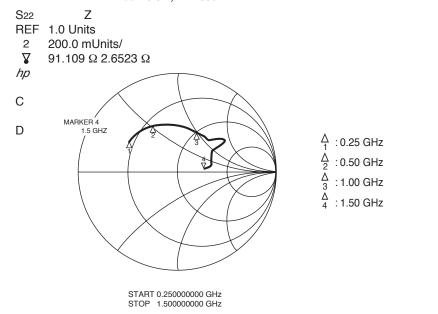


S	22
MAG	ANG
0.526 0.463	118.9 131.2
0.460	124.7 117.1 110.2
0.456	103.0 94.8
0.438 0.444	91.1 83.9
0.435	78.3 71.8 65.9
0.431 0.431	60.3 53.7
0.408	49.2 44.9 41.0
0.428 0.429 0.355	41.0 33.7 42.7
0.418 0.403	20.0 17.1
0.368	9.6 3.3 -3.4
0.319 0.289	-9.2 -14.1
	MAG 0.526 0.463 0.466 0.460 0.441 0.456 0.353 0.438 0.444 0.436 0.435 0.431 0.431 0.431 0.431 0.431 0.435 0.428 0.429 0.355 0.418 0.403 0.392 0.368 0.343 0.319

S22 vs. OUTPUT FREQUENCY



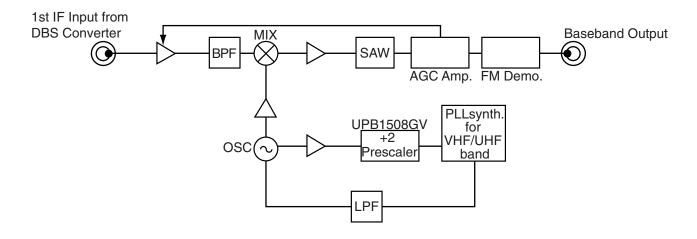
FREQUENCY



GHz	MAG	ANG
0.25	0.555	146.6
0.30	0.545	139.9
0.35	0.571	136.1
0.40	0.529	127.9
0.45	0.521	122.4
0.50	0.515	116.9
0.55	0.510	104.5
0.60	0.492	106.6
0.65	0.487	100.9
0.70	0.482	95.3
0.75	0.473	89.9
0.80	0.461	83.8
0.85	0.454	78.4
0.90	0.449	72.3
0.95	0.430	69.6
1.00	0.443	64.3
1.10	0.440	52.3
1.15	0.438	46.0
1.20	0.501	37.5
1.25	0.408	32.9
1.30	0.388	25.1
1.35	0.359	16.3
1.40	0.335	9.7
1.45	0.304	3.1
1.50	0.285	4.6

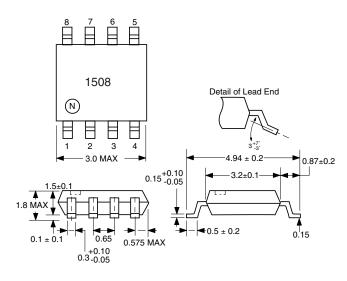
S22

SYSTEM APPLICATION EXAMPLE

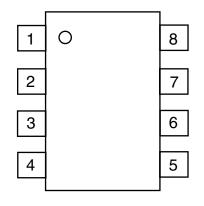


OUTLINE DIMENSIONS (Units in mm)

PIN CONNECTION



PACKAGE OUTLINE S08



Ρ	IN CON	NECT	IONS
1	Vcc	5	GND

0.	GIND
6.	NC
7.	OUT
8.	NC
	7.

ORDERING INFORMATION

PART NUMBER	QUANTITY
UPB1508GV-E1-A	1000/Reel

Note:

1. Embossed tape 8 mm wide.

Pin 1 is in the tape pull-out direction.

Life Support Applications

These NEC products are not intended for use in life support devices, appliances, or systems where the malfunction of these products can reasonably be expected to result in personal injury. The customers of CEL using or selling these products for use in such applications do so at their own risk and agree to fully indemnify CEL for all damages resulting from such improper use or sale.

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Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)		
Lead (Pb)	< 1000 PPM	-A -AZ Not Detected (*)	
Mercury	< 1000 PPM	Not Detected	
Cadmium	< 100 PPM	Not Detected	
Hexavalent Chromium	< 1000 PPM	Not Detected	
РВВ	< 1000 PPM	Not Detected	
PBDE	< 1000 PPM	Not Detected	

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

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